

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

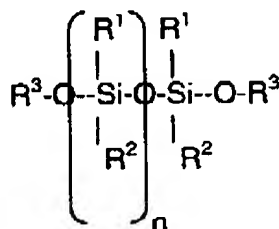
1. (Previously submitted) A composition comprising:
 - (a) from about 15% to about 50%, by weight of the total composition, of a silicone polymer;
 - (b) from about 5% to about 30% by weight of the total composition of a reinforcing filler;
 - (c) from about 20% to about 70% by weight of the total composition of an anti-tracking agent and a flame retardant;
 - (d) from about 0.01% to about 1% by weight of the total composition of a coupling agent;
 - (e) from about 0.1% to about 5% by weight of the total composition of a curing agent;
 - (f) up to about 20% by weight of the total composition of an extending filler; and
 - (g) from about 0.1% to about 5% by weight of the total composition of at least one processing fluid.

2. (original) A composition of claim 1 wherein:
 - (a) the silicone polymer comprises from about 25% to about 40%;
 - (b) the reinforcing filler comprises from about 8% to about 20%; and

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(c) the anti-tracking agent and the flame retardant comprises from about 25% to about 60%.

3. (Previously submitted) A composition of claim 2, wherein the silicone polymer is represented by recurring units of Formula I



Formula I

wherein:

R¹ independently at each occurrence represents C₁₋₄ alkyl, or C₂₋₄ alkylene;

R² independently at each occurrence represents C₁₋₄ alkyl, C₁-C₄ haloalkyl, or C₂₋₄ haloalkyl, or C₂₋₄ alkylene;

R³ independently at each occurrence represents H, C₁₋₁₀ alkyl, C₂₋₄ alkylene, C₄₋₆ cycloalkyl, C₁-C₄ haloalkyl, or OH; and

n represents an integer from 1,000 to 20,000.

4. (original) A composition of claim 3 wherein

R¹ independently at each occurrence represents, CH₃ or CH=CH₂;

R² independently at each occurrence represents CH₃, CH₂CH₂CF₃, or CH=CH₂.

R^3 at each occurrence represents CH_3 , $CH=CH_2$, OH , or $CH_2CH_2CF_3$; and

n represents an integer from about 4,000 to about 10,000.

5. (original) A composition of claim 3 wherein the vinyl content of the silicone polymer ranges from about 0.05% to about 0.5% by weight of the silicone polymer.
6. (original) A composition of claim 5 wherein the reinforcing filler is fumed silica, precipitated silica, or carbon black having a surface area of from about 50 to about 400 m^2/g .
7. (previously presented) A composition of claim 5 wherein the coupling agent is vinyltriethoxysilane (VTES), vinyltrimethoxysilane, or methacrylpropyltrimethoxysilane.
8. (original) A composition of claim 5 wherein the curing agent is a peroxide based curing agent.
9. (previously presented) A composition of claim 8 wherein the curing agent is a diacylperoxide, ketone peroxide, or dialkyl peroxide.
10. (previously presented) A composition of claim 5 wherein the extending filler is ground quartz, calcium carbonate, magnesium silicate, or magnesium aluminum silicate.

- 11.(previously presented) A composition of claim 5 wherein the processing fluid is a methyl or hydroxy terminated polydimethyl siloxane.
- 12.(original) A composition of claim 5 further comprising a mold release agent, a coloring agent, or a heat resistive agent.
- 13.(original) A composition of claim 12 wherein the mold release agent is a silicone fluid, magnesium, aluminum, or cerium stearate.
- 14.(original) A composition of claim 13 wherein the heat resistive agent is a cerium octoate, cerium hydroxide, magnesium oxide, cerium oxide, or magnesium hydroxide.
- 15.(original) A composition of claim 1 wherein upon heat curing the composition, the heat cured composition comprises a high voltage insulating composition.
- 16.(original) A process for making a high voltage insulating composition, the process comprising heat curing the composition of claim 1.
- 17.(currently amended) A silicone rubber composition comprising:
- (A) 100 weight parts organopolysiloxane gum having at least 2 silicon-bonded alkenyl groups in each molecule and the average compositional formula:



in which R is selected from substituted and unsubstituted monovalent hydrocarbon groups and a has a value of about 2 ~~from 1.95 to 2.05~~;

- (B) 10 to 300 weight parts aluminum hydroxide powder;
- (C) 0.1 to 1 weight part of a silane coupling agent, and
- (D) 0.1 to 5 weight parts of a peroxide based curing agent.

18. (canceled)

19. (previously presented) A composition according to claim 17, where the organopolysiloxane gum is a dimethylvinylsiloxyl-endblocked dimethylsiloxane-methylvinylsiloxane copolymer, a dimethylvinylsiloxyl-endblocked dimethylpolysiloxane, silanol-endblocked dimethylsiloxane-methylvinylsiloxane copolymer, or a methylvinylhydroxysiloxyl-endblocked dimethylsiloxane-methylvinylsiloxane copolymer.

20. (previously presented) A composition according to claim 17, where the aluminum hydroxide powder has a particle size large enough to provide arc resistance necessary for prolonged use and small enough so as to not adversely affect the processability of the composition.

21. (previously presented) A composition according to claim 17, where the aluminum hydroxide powder has a particle size of less than about 10 micrometers.

22. (previously presented) A composition according to claim 17 comprising 50 to 200 weight parts of aluminum hydroxide powder per 100 weight parts of the organopolysiloxane gum.

23. (previously presented) A composition according to claim 17, where the silane coupling agent is a silane having alkenyl and alkoxy substitution.

24. (previously presented) A composition according to claim 23, where the silane coupling agent is vinyltrimethoxysilane.

25. (canceled)

26. (canceled)

27. (canceled)

28. (canceled)

29. (canceled)

30. (canceled)

31. (canceled)

32. (canceled)

33. (previously presented) The composition of Claim 1, wherein the processing fluid is selected from the group consisting of an alkylpolysiloxane oil capped with hydroxyl, allyl or phenyl groups at both terminal end of the molecular chain and a phenyl polysiloxane oil capped with hydroxyl, allyl or phenyl groups at both terminal ends of the molecular chain.